2SA2010

Silicon PNP epitaxial planar type

For DC-DC converter

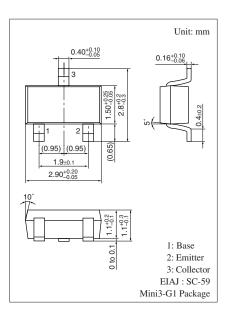
For various driver circuits

Features

- Low collector-emitter saturation voltage $V_{CE(sat)}$
- High-speed switching
- Mini type package, allowing downsizing and thinning of the equipment and automatic insertion through the tape packing.

Symbol	Rating	Unit						
V _{CBO}	V _{CBO} -15							
V _{CEO}	-15	V						
V _{EBO}	-5	V						
I _C	-2.5	А						
I _{CP}	-10	А						
P _C	600	mW						
Tj	150	°C						
T _{stg}	-55 to +150	°C						
	Symbol V _{CBO} V _{CEO} V _{EBO} I _C P _C T _j	$\begin{tabular}{ c c c c } \hline Symbol & Rating \\ \hline V_{CBO} & -15 \\ \hline V_{CEO} & -15 \\ \hline V_{EBO} & -5 \\ \hline I_C & -2.5 \\ \hline I_{CP} & -10 \\ \hline P_C & 600 \\ \hline T_j & 150 \\ \hline \end{tabular}$						

Absolute Maximum Ratings $T_a = 25^{\circ}C$



Marking Symbol: AS

Note) *: Measure on the ceramic substrate at 15 mm \times 15 mm \times 0.6 mm

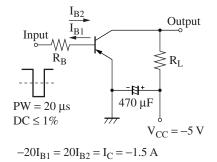
Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V _{CBO}	$I_{C} = -10 \ \mu A, \ I_{E} = 0$	-15			V
Collector-emitter voltage (Base open)	V _{CEO}	$I_{\rm C} = -1 {\rm mA}, I_{\rm B} = 0$	-15			V
Emitter-base voltage (Collector open)	V _{EBO}	$I_{\rm E} = -10 \ \mu A, \ I_{\rm C} = 0$	-5			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = -10 \text{ V}, I_E = 0$			- 0.1	μΑ
Forward current transfer ratio *	h _{FE1}	$V_{CE} = -2 V, I_C = -100 mA$	200		560	_
	h _{FE2}	$V_{CE} = -2 V, I_C = -2.5 A$	100			
Collector-emitter saturation voltage *	V _{CE(sat)}	$I_{C} = -1 A, I_{B} = -10 mA$		-140		mV
		$I_{\rm C} = -2.5 \text{ A}, I_{\rm B} = -50 \text{ mA}$		-270	-320	
Transition frequency	f _T	$V_{CB} = -10 \text{ V}, I_E = 50 \text{ mA}, f = 200 \text{ MHz}$		180		MHz
Collector output capacitance	C _{ob}	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		40		pF
(Common base, input open circuited)						
Turn-on time	t _{on}	Refer to the measurement circuit		35		ns
Turn-off time	t _{off}			10		ns
Storage time	t _{stg}			110		ns

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *: Pulse measurement

Measurement Circuit



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